## PRODUCT DATA SHEET

# PoP Flux 8,9HF-LV

## Package-on-Package

#### Introduction

**PoP Flux 8.9HF-LV** is a thixotropic no-clean flux designed for package-on-package applications with Pb-free solders. **PoP Flux 8.9HF-LV** has a unique halogen-free activator system.

#### **Features**

- · Application by dipping or dispensing
- Halogen-free (no intentionally-added halides)
- Optimized for Pb-free (SAC alloy) applications
- Excellent solderability with Cu-OSP, AuNi, and immersion Ag finishes
- · Air reflow
- · Bubble-free packaging

#### **Properties**

•	Value	Test Method
Flux Type Classification	ROL0	J-STD-004 (IPC-TM-650: 2.3.32 and 2.3.33)
Typical Viscosity	8.5kcps	Cone and plate viscosity (5 minutes)
SIR (Ohms, after reflow)	Pass (>10 <sup>8</sup> after 7 days @ 85°C & 85% RH)	J-STD-004 (IPC-TM-650: 2.6.3.3 IPC-B-24)
Typical Acid Value	120mg KOH/g	Titration
Typical Tack Strength	170g	J-STD-005 (IPC-TM-650: 2.4.44)
Shelf Life	1 year (0°C–30°C)	Viscosity Change/ Microscope Examination
Color	Light Amber	Visual

All information is for reference only. Not to be used as incoming product specifications.

#### **Application**

The volume of flux on the package can be optimized by changing equipment parameters. Key variables include: sphere size, sphere pitch, flux shear speed, and dwell. Viscosity can be optimized per application by appropriate equipment setup.



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### **Cleaning**

**PoP Flux 8.9HF-LV** is designed for no-clean applications, and can be left in place on the final package. If necessary, flux residues can be removed by using a commercially available flux cleaner. Contact an Indium Corporation Technical Support Engineer for recommendations on flux cleaners.

### **Packaging**

**PoP Flux 8.9HF-LV** is available only in air-free 30cc syringes.



From One Engineer To Another

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#### **Storage**

For maximum shelf life, **PoP Flux 8.9HF-LV** syringes and cartridges should be stored tip down. Storage temperatures should never exceed 30°C. After removing from cold storage, **PoP Flux 8.9HF-LV** should be allowed to stand for at least four hours at room temperature before using.

#### **Technical Support**

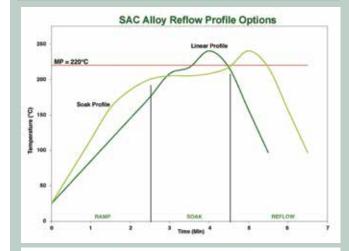
Indium Corporation sets the industry standard in providing rapid response, on-site technical support for our customers worldwide. Indium Corporation's team of Technical Support Engineers can provide expertise in all aspects of Materials Science and Semiconductor Packaging process applications.

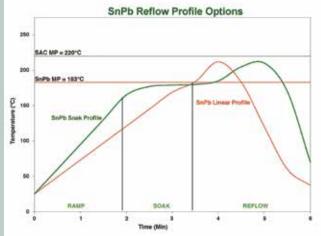
#### **Safety Data Sheets**

The SDS for this product can be found online at http://www.indium.com/sds



#### **Recommended Profile:**





Peak reflow temperature should be  $<250^{\circ}$ C in an air or nitrogen atmosphere, with a linear ramp up to approximately  $30^{\circ}$ C above the solidus temperature.

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Contact our engineers today: askus@indium.com

Learn more: www.indium.com

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